# SiD Tracking Performance at High/Energies



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**2011 ALCPG Meeting** 

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# • SiD • Tracking in SiD

- SiD has a 100% silicon tracker composed of inner pixel layers and outer strip layers treated as an integrated tracking system
  - Pixel sensors covers r < 200mm region with 5 barrel and 7 endcap layers
  - Strip sensors cover r > 200mm region with 5 barrel and 4 endcap layers
  - Barrel strip layers have axial strips that only measure the bend coordinate
  - Endcap strip layers have pairs of trapezoidal sensors with 12° stereo angle to measure both the bend and non-bend coordinates



# **Tracker Design Metrics**

- Low-mass silicon vertex and tracking detectors to minimize the effect of multiple scattering
  - Roughly 10% X<sub>0</sub> except for barrel/endcap transition and far forward regions
- $\diamond$  ~10 tracking layers with excellent resolution and 2-hit separation to provide robust pattern recognition capabilities



### SiD · Momentum Resolution

• Momentum resolution typically ~0.2% for  $|\cos(\theta)| < 0.65$ 

•  $\sigma(p_T) / p_T < 0.5\%$  over most of solid angle for 1 GeV  $< p_T < 100$  GeV



#### SiD · Impact Parameter Resolution

• DCA resolution typically ~15 $\mu$ m for p<sub>T</sub> = 1 GeV,  $|\cos(\theta)| < 0.65$ 

Most tracks multiple scattering limited – resolution approaches  $\sim 4\mu m$  at high  $p_T$ 



### • Side • Tracking Pattern Recognition

- Determining track-finding performance in complex physics events requires:
  - Detailed simulation of the tracking sensors to transform GEANT energy deposits into tracker hits
  - Pattern recognition code that finds tracks among the constellation of hits
- SiD has developed tracking code (SeedTracker) in the lcsim framework explicitly intended for detector design studies
  - Tracking code makes no assumptions about detector geometry, so new detector designs can be tried without modifying/re-tuning the tracking code
  - User control of tracking algorithm is through a list of tracking "strategies" to be tried, with each strategy specifying which layers to use in track finding, the role of each layer, constraints on  $p_T$  and impact parameter, and a  $\chi^2$  cut
  - SeedTracker algorithm then provides an exhaustive search of all combinations of hits that could potentially form a track to find the best track candidates

# • SiD • SeedTracker Algorithm

- SiD has developed track finding code in the lcsim framework Track finding begins by forming all possible 3 hit track seeds Seed in the three "Seed Layers" Brute force approach to finding all possible track seeds Require the presence of a hit in a "Confirmation Layer" • Significantly reduces the number of candidate tracks to be investigated Add hits to the track candidate using hits on the "Extension Layers" Discard track candidates with fewer than 7 hits (6 hits for barrel only tracks)
  - If two track candidates share more than one hit, best candidate is selected
    Upon each attempt to add a hit to a track candidate, a helix fit is performed and a global χ<sup>2</sup> is used to determine if the new
    - track candidate is viable

# • SiD • Track Finding Strategy

- The user interacts with the track reconstruction program by specifying one or more "strategies"
- Typical strategy requirements:
  - At least 7 hits on the track
    - Only 1 hit per layer
    - Special barrel only strategy with 6 hits used to pick up low- $p_T$  particles in the central region
  - **p**<sub>T</sub> > 0.2 GeV
  - r  $\phi$  and s z impact parameter cuts  $|d_0| < 10$  mm and  $|z_0| < 10$  mm
  - $\chi^2 < 25$
  - Bad hit  $\chi^2$  parameter = 10 (used to ignore a single outlier hit)
- "Strategy Builder" used to find optimized sets of seed and confirm layers used for efficient track finding
- The remainder of this talk will focus on post-LOI improvements to the tracking code and performance measurements for complex events (ttH @ 1TeV)

# • SiD • New Planar Geometry



LOI geometry consisted of cylinders and disks with virtual segmentation



New geometry models each silicon sensor – rectangular detectors in barrel, trapezoidal detectors in endcaps

### • SiD • Realistic Detector Geometry

Blow-up of vertex detector showing hits on planar sensors



# • SiD LOI Geometry – CAD Drawing



### • SiD LOI Geometry – Event Display



# • Side Event Display / CAD Drawing Overlay



# • SD • Realistic Hit Digitization

- In LOI studies, charge was deposited on the nearest strip/pixel
- New code provides detailed simulation of charge deposition, Lorentz drift, diffusion, and charge sharing between adjacent strips/pixels
  - Charge deposition for strip detectors based on CDF Si sensor simulation algorithm
  - For pixels, can either use strip deposition model extended to pixels or detailed modeling using electric field maps
- Readout chip code accounts for noise and readout threshold and produces raw hits
- Raw hits are clustered using a nearest neighbor algorithm
- Tracker hits are formed giving hit position and uncertainty

# <sup>*iH*</sup> SiD • Tracking Efficiency

- Some tracks are not findable by the tracking algorithm
  - $p_T$  too low, not enough hits on the track, impact parameter too big, etc.

#### Breakdown of reasons a track isn't found

Selection	LOI: $t\bar{t}$ @ 500 GeV	New: $t\bar{t}H$ @ 1 TeV
$p_{\rm T} \ge 0.2 {\rm ~GeV}$	$(93.45 \pm 0.11)\%$	$(94.02 \pm 0.11)\%$
Nhit $\geq 6$	$(90.77 \pm 0.13)\%$	$(91.54 \pm 0.12)\%$
Seed Hits Present	$(99.77 \pm 0.02)\%$	$(99.76 \pm 0.02)\%$
Confirm Hit Present	$(99.96 \pm 0.01)\%$	$(99.97 \pm 0.01)\%$
$ \mathbf{d}_0  \le 1 \text{ cm}$	$(99.83 \pm 0.02)\%$	$(99.80 \pm 0.02)\%$
$ z_0  \le 1 \text{ cm}$	$(99.72 \pm 0.03)\%$	$(99.81 \pm 0.02)\%$
Track Reconstruction	$(99.05 \pm 0.05)\%$	$(98.78 \pm 0.05)\%$

- Tracking performance is very similar to LOI
- Track reconstruction algorithm has ~99% efficiency for findable tracks

# $\cdot \mathfrak{SD} \cdot \mathbf{Tracking}$ Efficiency vs $\mathbf{p}_{\mathrm{T}}$

LOI (tt @ 500 GeV)

Planar Sensors and Realistic Digitization (ttH @ 1 TeV)



# • $\mathfrak{SD}$ • Tracking Efficiency vs $\cos(\theta)$



LOI (tt @ 500 GeV)

Planar Sensors and Realistic Digitization (ttH @ 1 TeV)

# • SiD • Comparison with MC Truth

Identify which MC particles are associated with each hit

- Assign track to the MC particle that contributes the most hits
- Count how many hits on the track are from other MC particles



# · SiD · Fake Tracks

- Define a fake track as one that has fewer than half of its hits from a single MC particle
- Fake track rate in 1 TeV ttH sample (0.79%) is considerably higher than seen in the LOI for 500 GeV tt sample (0.07%)
- Fake tracks have minimum number of hits allowed



SD • Where are Fake Tracks Located?

Fake tracks are generally in the central region where the tracker has only axial strips – z coordinate is only constrained by ~92 mm length of strip



SiD · Fake Track Momentum

Fake tracks tend to be low momentum, but there is a tail to high momentum



Richard Partridge

### • SiD • Goodness of Fit

Fake tracks typically have larger  $\chi^2$  than non-fake tracks



# SiD · Summary

- Introduction of planar sensors and realistic hit digitization has improved realism of SiD tracking simulations
- Tracking efficiency for findable tracks in 1 TeV ttH events is ~99% with these improvements
  - Very similar to what was achieved in the LOI for 500 GeV tt events
- ◆ Fake track rate for 1 TeV ttH events is ~0.8%
  - Roughly an order of magnitude higher than in the LOI
  - Fakes have minimum multiplicity, concentrated in barrel region
  - If this fake rate proves problematic, can either increase number of hits required for a track (with some loss of efficiency at low momentum) or introduce additional measurements (stereo or pixel layers in tracker)
- Algorithm improvements (and a few bug fixes) have substantially improved track reconstruction speed
  - Average of 120 seconds / event for complex 1 TeV ttH events
  - See talk in software session later today